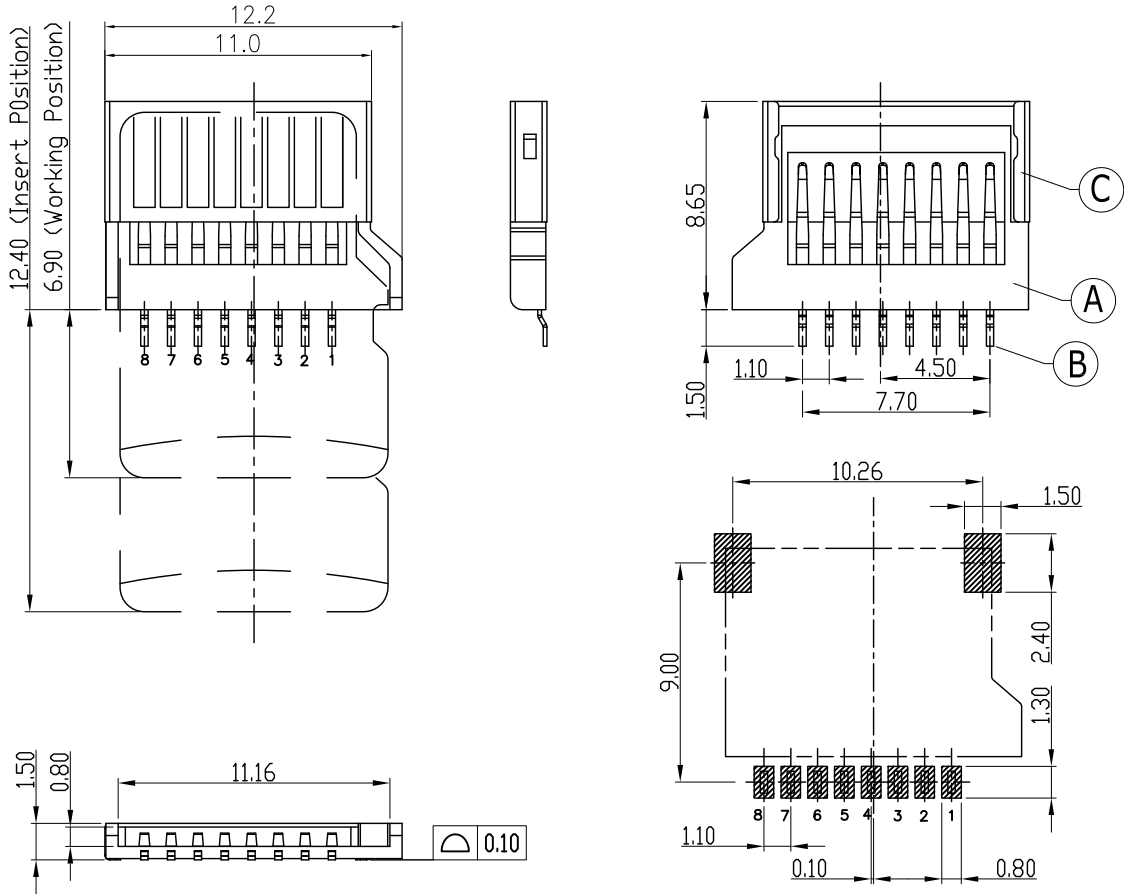


1	2	3	4	5	6	7	8	9	10
SWITCH CIRCUIT			MATERIAL AND FINISH AS BELOW						
WHEN CARD IS EJECTED		WHEN CARD IS INSERTED		A	Housing	LCP UL94V-0 Black	D		
				B	Contact	Phosphor Bronze C5191, Contact Area: 3u" Gold	E		
				C	Shell	Stainless Steel SUS304, Nickel Plating Gold Flash on Solder Area.	F		
							G		




**SPECIFICATION:**

- 1. ELECTRICAL**
  - 1.1 Current Rating: 0.5A
  - 1.2 Voltage Rating: 100V AC/DC
  - 1.3 Contact Resistance: 50mΩ
  - 1.4 Insulation Resistance: 1000MΩ
  - 1.5 Dielectric Withstanding Voltage: 500VDC
- 2. MECHANICAL**
  - 2.1 Durability: 10000 Cycle
  - 2.2 Insertion Force: 9.8N max.
  - 2.3 Extraction Force: 9.8N max.
- 3. ENVIRONMENTAL**
  - 3.1 Operating temperature range: -40°C~+85°C
  - 3.2 Storage temperature range: -40°C~+85°C
- 4. SOLDER ABILITY**
  - 4.1 Recommended IR Reflow Temperature: 260°C

DAT2	CD/DAT3	CMD	VDD	CLK	VSS	DAT0	DAT1			
P1	P2	P3	P4	P5	P6	P7	P8	P9	P10	P11

PIN ASSIGNMENT										
112K-TBA0-RA1		Micro SD Socket , Without Cover, Contact Area:3u" Gold								
PRODUCT NO.		DESCRIPTION								

		UNLESS OTHERWISE SPECIFIED TOLERANCE								
ANGLES		ANG.	±5°							
LINEAR		0.	±0.3							
		0.00	±0.25							
SCALE		AS SHOWN	UNIT: mm		www.attend.com.tw					
DRAWN		Willis	2013/09/24		DRAWN NAME:					
CHECKED		Angel	2013/09/24		Micro SD Socket Without Cover					
APPROVED		Ken	2013/09/24		PRODUCT NO.					
REV.			SIZE A4		REV. 1.0					
FILE NAME		112K-TBA0-RA1_B_1								

REV.	DESCRIPTION	DATE	REV.	DESCRIPTION	DATE
1					
2					
3					
4					
5					
6					
7					
8					
9					
10					

- △ Revise:
- △ Revise:
- △ Revise: